Emitter common (dual digital transistors) UMG2N / FMG2A

Features

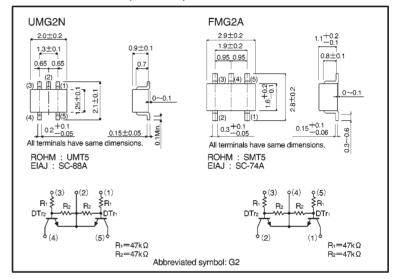
- Two DTC144E chips in a UMT or SMT package.
- Mounting cost and area can be cut in half.

Structure

Dual NPN digital transistor (each with two built in resistors)

The following characteristics apply to both DTr₁ and DTr₂.

External dimensions (Units: mm)



● Absolute maximum ratings (Ta = 25°C)

Parameter		Symbol	Limits	Unit	
Supply voltage		Vcc	50	V	
Input voltage		VIN	40	V	
		A livi	-10		
Output current		lo	30	mA	
		IC(Max.) 100		T IIIA	
Power dissipation	UMG2N	Pd	150 (TOTAL)	*1 mW	
	FMG2A	Fu	300 (TOTAL)	*2	
Junction temperature		Tj	150	°C	
Storage temperature		Tstg	− 55∼ + 150	Ĉ	

*1 120mW per element must not be exceeded.

*2 200mW per element must not be exceeded.

Transistors UMG2N / FMG2A

• Electrical characteristics (Ta = 25°C)

Parameter	Symbol	Min.	Тур.	Max.	Unit	Conditions	
Input voltage	VI (off)	_	_	0.5	V	Vcc=5V, Io=100 μ A	
Input voltage	VI (on)	3	_	_		Vo=0.3V, Io=2mA	
Output voltage	Vo(on)	_	0.1	0.3	V	Io/I ₁ =10mA/0.5mA	
Input current	lı	_	_	0.18	mA	V:=5V	
Output current	lo (off)	_	_	0.5	μΑ	Vcc=50V, Vi=0V	
DC current gain	Gı	68	_	_	_	Vo=5V, Io=5mA	
Transition frequency	f⊤	_	250	_	MHz	Vc=10mA, I=-5mA, f=100MHz *	
Input resistance	R ₁	32.9	47	61.1	kΩ	_	
Resistance ratio	R2/R1	0.8	1	1.2	_	_	

^{*} Transition frequency of the device

Packaging specifications

	Packaging type	Taping		
	Code	TR	T148	
Part No.	Basic ordering unit (pieces)	3000	3000	
UMG2N		0	_	
FMG2A		_	0	

•Electrical characteristic curves

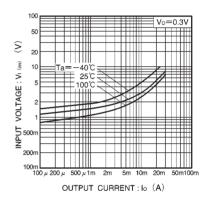


Fig.1 Input voltage vs. output current (on-characteristics)

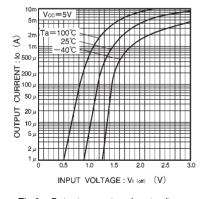


Fig.2 Output current vs. input voltage (off-characteristics)

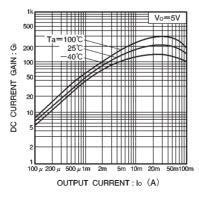


Fig.3 DC current gain vs. output current

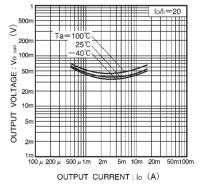


Fig.4 Output voltage vs. output current

